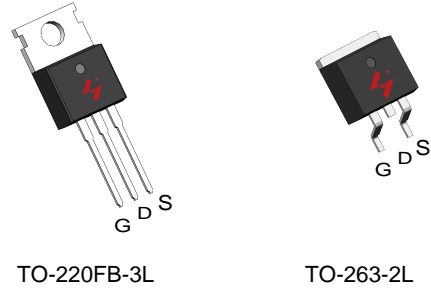


N-Channel Enhancement Mode MOSFET

Features

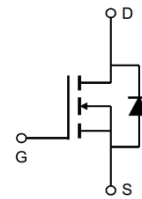
- 60V/190A
 $R_{DS(ON)} = 3.2\text{ m}\Omega$ (typ.) @ $V_{GS}=10V$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Pin Description




Applications

- Switching application
- Power Management for Inverter Systems.



N-Channel MOSFET

Ordering and Marking Information

| | | |
|---|---|--|
|  P HY3906 YYXXXJWW G |  B HY3906 YYXXXJWW G | Package Code P : TO-220FB-3L B : TO-263-2L |
| | | Date Code Assembly Material YYXXX WW G : Lead Free Device |

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this product and/or to this document at any time without notice.

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit | |
|--|--|---------------------------|--------------------|-----------------------------|
| Common Ratings ($T_C=25^{\circ}\text{C}$ Unless Otherwise Noted) | | | | |
| V_{DSS} | Drain-Source Voltage | 60 | V | |
| V_{GSS} | Gate-Source Voltage | ± 25 | | |
| T_J | Maximum Junction Temperature | 175 | $^{\circ}\text{C}$ | |
| T_{STG} | Storage Temperature Range | -55 to 175 | $^{\circ}\text{C}$ | |
| I_S | Diode Continuous Forward Current | $T_C=25^{\circ}\text{C}$ | 190 | A |
| Mounted on Large Heat Sink | | | | |
| I_{DM} | Pulsed Drain Current * | $T_C=25^{\circ}\text{C}$ | 720** | A |
| I_D | Continuous Drain Current | $T_C=25^{\circ}\text{C}$ | 190 | A |
| | | $T_C=100^{\circ}\text{C}$ | 128 | |
| P_D | Maximum Power Dissipation | $T_C=25^{\circ}\text{C}$ | 220 | W |
| | | $T_C=100^{\circ}\text{C}$ | 110 | |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | | 0.68 | $^{\circ}\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient | | 62.5 | |
| Avalanche Ratings | | | | |
| E_{AS} | Avalanche Energy, Single Pulsed | $L=0.5\text{mH}$ | 1.3*** | J |

Note : * Repetitive rating ; pulse width limited by junction temperature
 ** Drain current is limited by junction temperature
 *** $V_D=48\text{V}$

Electrical Characteristics ($T_C = 25^{\circ}\text{C}$ Unless Otherwise Noted)

| Symbol | Parameter | Test Conditions | HY3906 | | | Unit |
|-------------------------------|----------------------------------|---|--------|------|-----------|------------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}, I_{DS}=250\mu\text{A}$ | 60 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=60\text{V}, V_{GS}=0\text{V}$ $T_J=85^{\circ}\text{C}$ | - | - | 1 | μA |
| | | | - | - | 10 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_{DS}=250\mu\text{A}$ | 2.0 | 3.0 | 4.0 | V |
| I_{GSS} | Gate Leakage Current | $V_{GS}=\pm 25\text{V}, V_{DS}=0\text{V}$ | - | - | ± 100 | nA |
| $R_{DS(ON)*}$ | Drain-Source On-state Resistance | $V_{GS}=10\text{V}, I_{DS}=95\text{A}$ | - | 3.2 | 4.0 | $\text{m}\Omega$ |
| Diode Characteristics | | | | | | |
| V_{SD}^* | Diode Forward Voltage | $I_{SD}=95\text{A}, V_{GS}=0\text{V}$ | - | 0.8 | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_{SD}=95\text{A}, dI_{SD}/dt=100\text{A}/\mu\text{s}$ | - | 48 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 72 | - | nC |

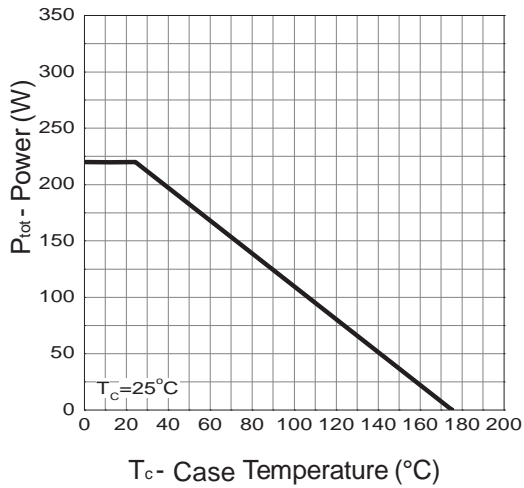
Electrical Characteristics (Cont.) (T_C = 25°C Unless Otherwise Noted)

| Symbol | Parameter | Test Conditions | HY3906 | | | Unit |
|------------------------------------|------------------------------|---|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Dynamic Characteristics | | | | | | |
| R _G | Gate Resistance | V _{GS} =0V, V _{DS} =0V, F=1MHz | - | 1.9 | - | Ω |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =25V, Frequency=1.0MHz | - | 5726 | - | pF |
| C _{oss} | Output Capacitance | | - | 1014 | - | |
| C _{rss} | Reverse Transfer Capacitance | | - | 506 | - | |
| t _{d(ON)} | Turn-on Delay Time | V _{DD} =30V, R _G =6 Ω, I _{DS} =95A, V _{GS} =10V, | - | 28 | - | ns |
| T _r | Turn-on Rise Time | | - | 18 | - | |
| t _{d(OFF)} | Turn-off Delay Time | | - | 42 | - | |
| T _f | Turn-off Fall Time | | - | 54 | - | |
| Gate Charge Characteristics | | | | | | |
| Q _g | Total Gate Charge | V _{DS} =48V, V _{GS} =10V, I _{DS} =95A | - | 135 | - | nC |
| Q _{gs} | Gate-Source Charge | | - | 24 | - | |
| Q _{gd} | Gate-Drain Charge | | - | 49 | - | |

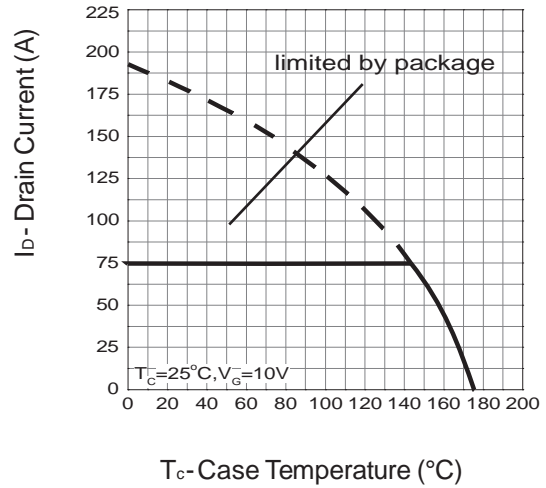
Note * : Pulse test ; pulse width ≤ 300μs, duty cycle ≤ 2%.

Typical Operating Characteristics

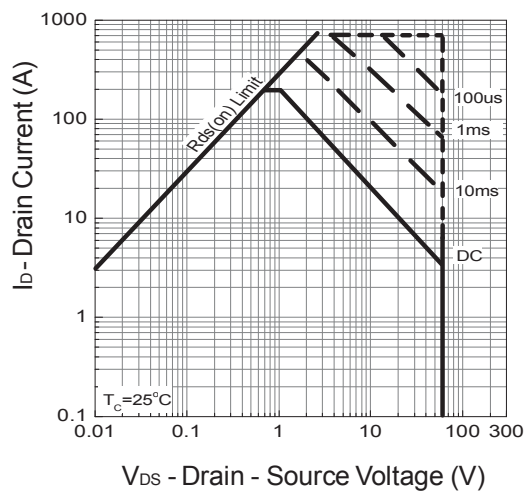
Power Dissipation



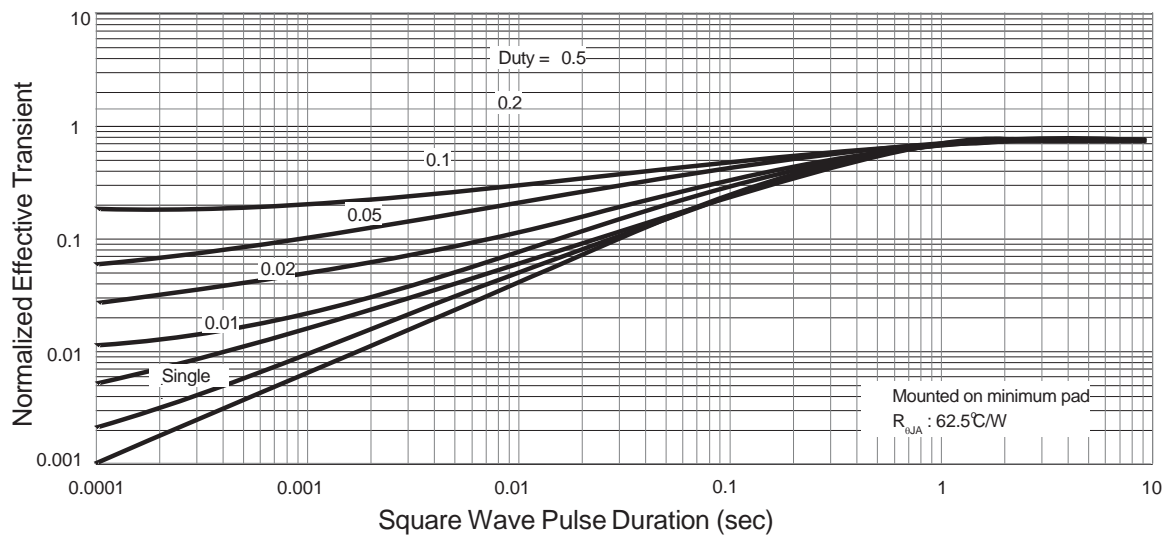
Drain Current



Safe Operation Area

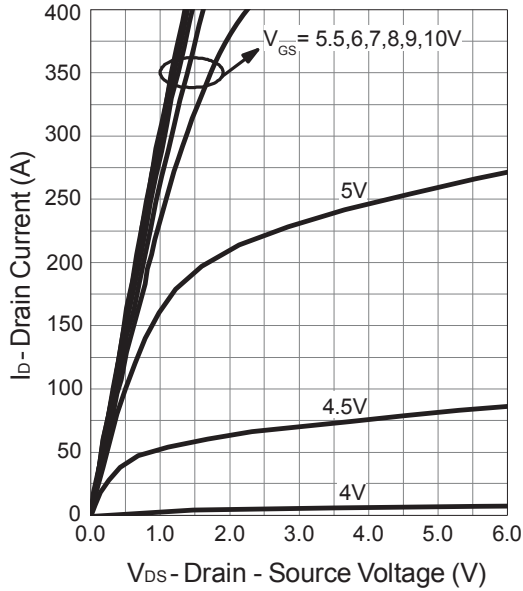


Thermal Transient Impedance

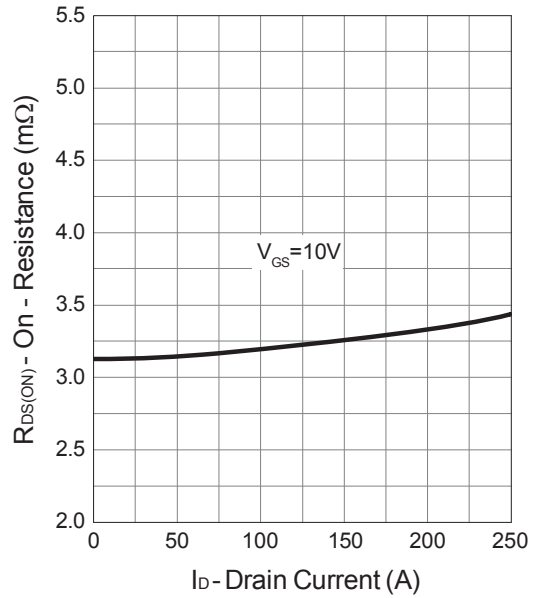


Typical Operating Characteristics (Cont.)

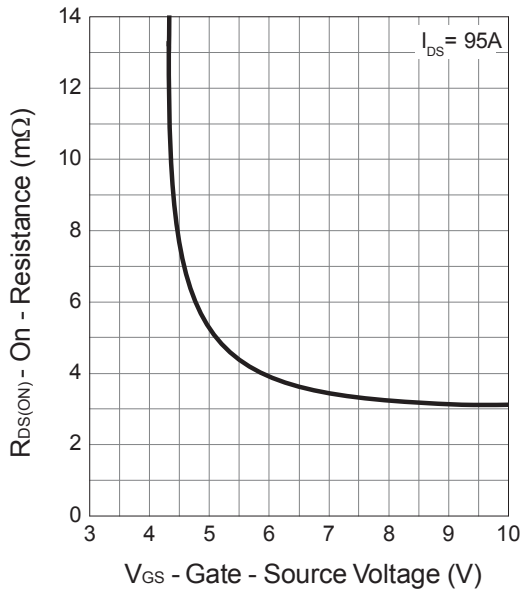
Output Characteristics



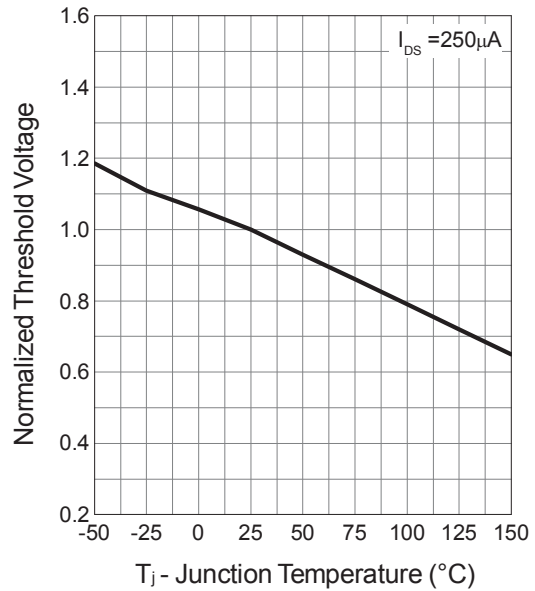
Drain-Source On Resistance



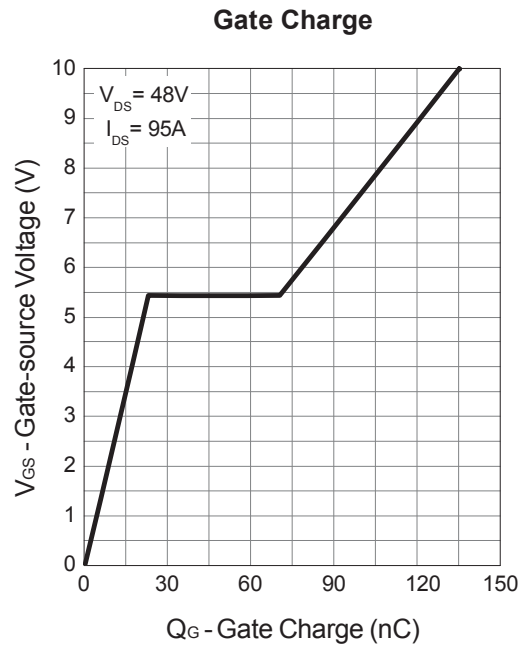
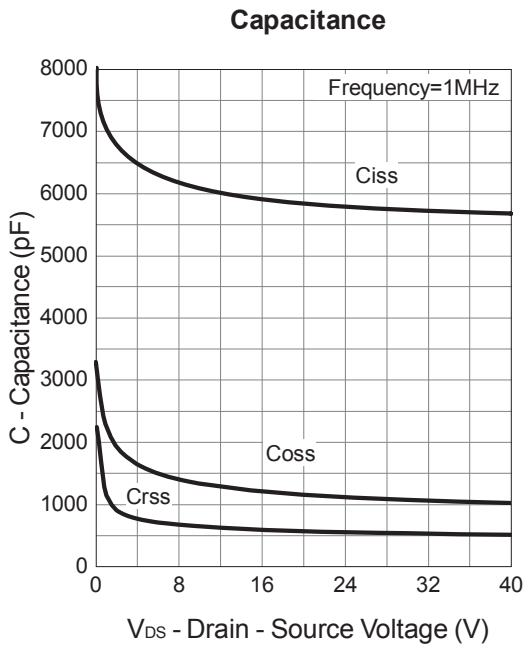
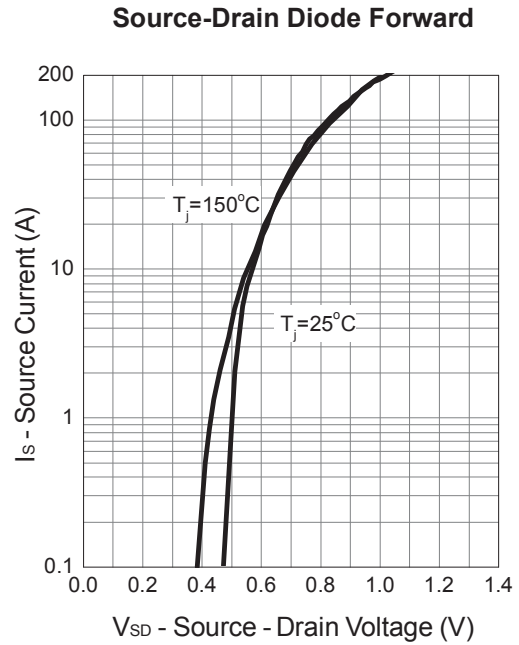
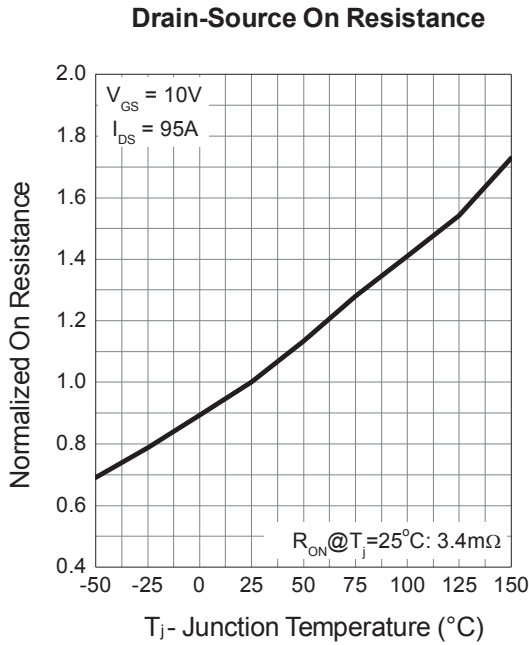
Gate-Source On Resistance



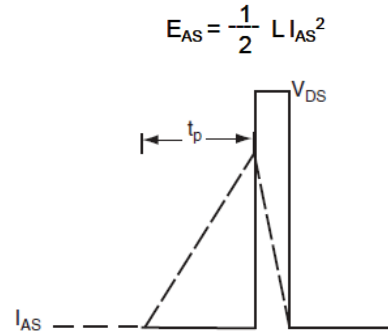
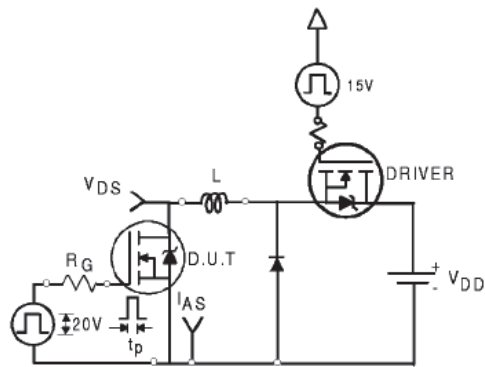
Gate Threshold Voltage



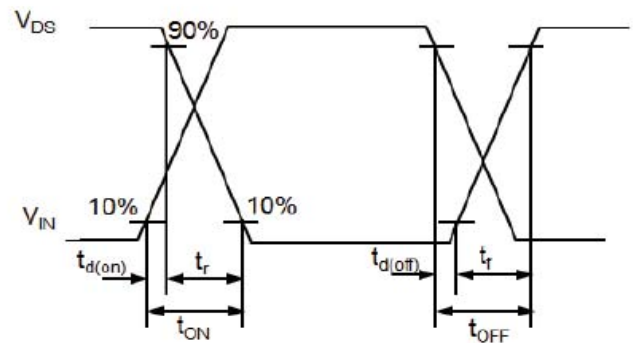
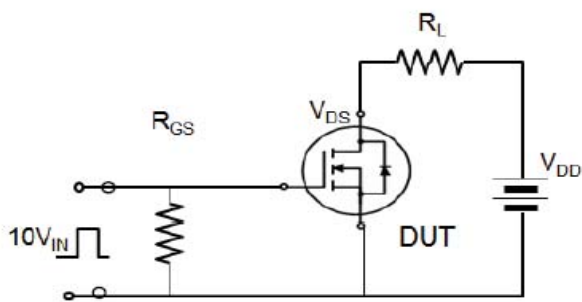
Typical Operating Characteristics (Cont.)



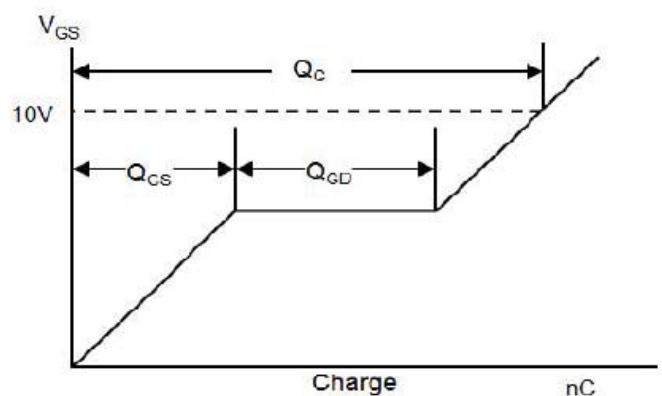
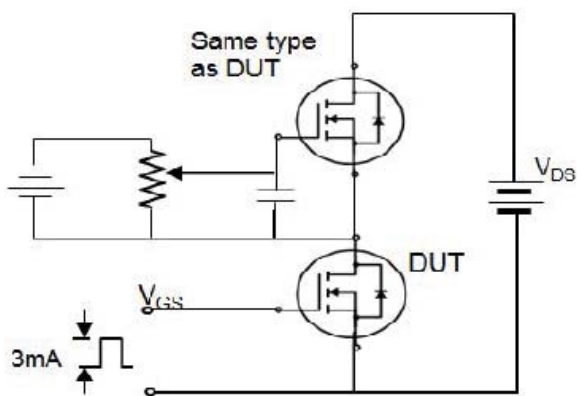
Avalanche Test Circuit



Switching Time Test Circuit



Gate Charge Test Circuit

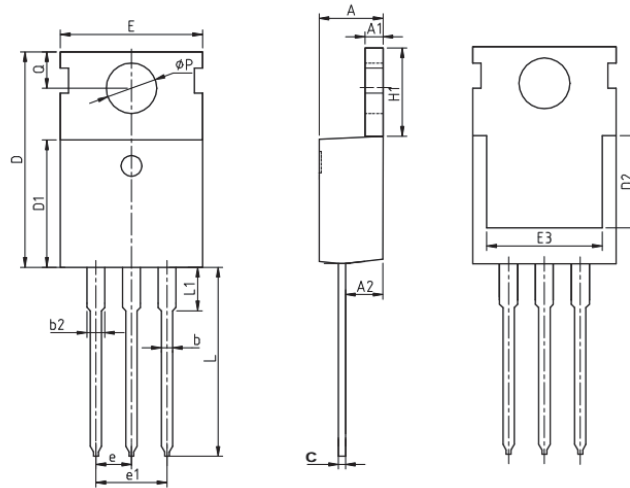


Device Per Unit

| Package Type | Unit | Quantity |
|--------------|------|----------|
| TO-220FB-3L | Tube | 50 |

Package Information

TO-220FB-3L



COMMON DIMENSIONS

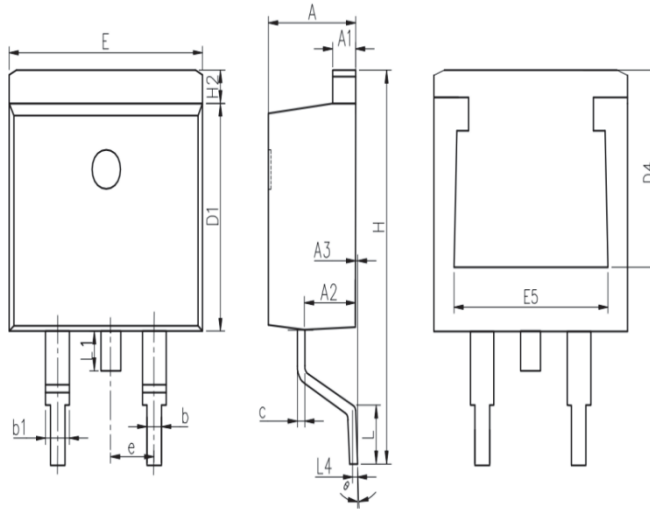
| SYMBOL | mm | | |
|--------|----------|-------|-------|
| | MIN | NOM | MAX |
| A | 4.37 | 4.57 | 4.77 |
| A1 | 1.25 | 1.30 | 1.45 |
| A2 | 2.20 | 2.40 | 2.60 |
| b | 0.70 | 0.80 | 0.95 |
| b2 | 1.17 | 1.27 | 1.47 |
| c | 0.40 | 0.50 | 0.65 |
| D | 15.10 | 15.60 | 16.10 |
| D1 | 8.80 | 9.10 | 9.40 |
| D2 | 5.50 | - | - |
| E | 9.70 | 10.00 | 10.30 |
| E3 | 7.00 | - | - |
| e | 2.54 BSC | | |
| e1 | 5.08 BSC | | |
| H1 | 6.25 | 6.50 | 6.85 |
| L | 12.75 | 13.50 | 13.80 |
| L1 | - | 3.10 | 3.40 |
| ΦP | 3.40 | 3.60 | 3.80 |
| Q | 2.60 | 2.80 | 3.00 |

Device Per Unit

| Package Type | Unit | Quantity |
|--------------|------|----------|
| TO-263-2L | Reel | 50 |

Package Information

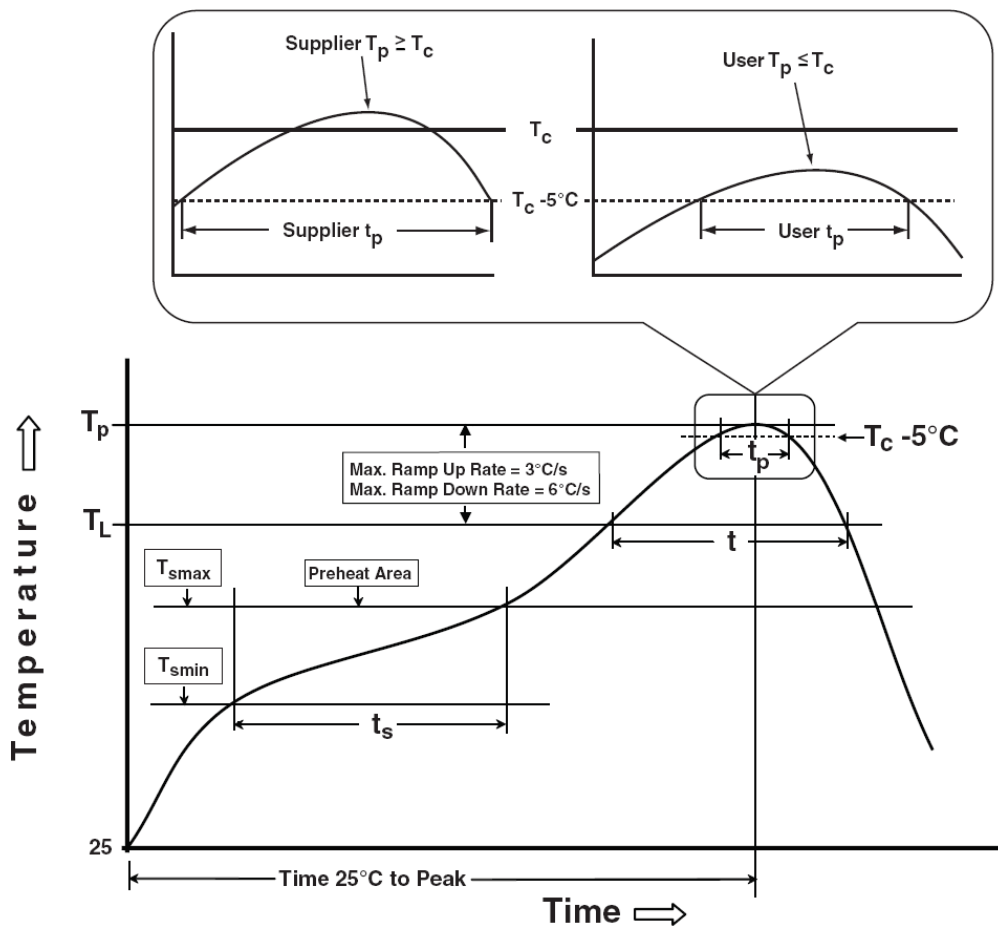
TO-263-2L



COMMON DIMENSIONS

| SYMBOL | mm | | |
|--------|----------|-------|-------|
| | MIN | NOM | MAX |
| A | 4.37 | 4.57 | 4.77 |
| A1 | 1.22 | 1.27 | 1.42 |
| A2 | 2.49 | 2.69 | 2.89 |
| A3 | 0 | 0.13 | 0.25 |
| b | 0.7 | 0.81 | 0.96 |
| b1 | 1.17 | 1.27 | 1.47 |
| c | 0.3 | 0.38 | 0.53 |
| D1 | 8.5 | 8.7 | 8.9 |
| D4 | 6.6 | - | - |
| E | 9.86 | 10.16 | 10.36 |
| E5 | 7.06 | - | - |
| e | 2.54 BSC | | |
| H | 14.7 | 15.1 | 15.5 |
| H2 | 1.07 | 1.27 | 1.47 |
| L | 2 | 2.3 | 2.6 |
| L1 | 1.4 | 1.55 | 1.7 |
| L4 | 0.25 BSC | | |
| θ | 0° | 5° | 9° |

Classification Profile



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|---|------------------------------------|------------------------------------|
| Preheat & Soak | | |
| Temperature min (T_{smin}) | 100 °C | 150 °C |
| Temperature max (T_{smax}) | 150 °C | 200 °C |
| Time (T_{smin} to T_{smax}) (t_s) | 60-120 seconds | 60-120 seconds |
| Average ramp-up rate (T_{smax} to T_p) | 3 °C/second max. | 3°C/second max. |
| Liquidous temperature (T_L) | 183 °C | 217 °C |
| Time at liquidous (t_L) | 60-150 seconds | 60-150 seconds |
| Peak package body Temperature (T_p)* | See Classification Temp in table 1 | See Classification Temp in table 2 |
| Time (t_p)** within 5°C of the specified classification temperature (T_c) | 20** seconds | 30** seconds |
| Average ramp-down rate (T_p to T_{smax}) | 6 °C/second max. | 6 °C/second max. |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. |

* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum.
 ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ ≥350 |
|-------------------|-----------------------------|-----------------------------|
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2. Pb-free Process – Classification Temperatures (Tc)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|-------------------|-----------------------------|---------------------------------|------------------------------|
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|---------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HTRB | JESD-22, A108 | 168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C |
| PCT | JESD-22, A102 | 96Hrs, 100%RH, 2atm, 121°C |
| TCT | JESD-22, A104 | 500 Cycles, -55°C~150°C |

Customer Service

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